

PATENT

Attorney Docket No.: SAM-0421

Applicant(s):

Kang-soo Chu, et al.

U.S. Serial No.:

10/612,028

Filing Date:

July 2, 2003

Examiner:

Pham, L.

Group Art Unit:

2814

Date of Notice of Allowance: September 30, 2004

Title:

SEMICONDUCTOR DEVICE HAVING AN ETCH STOPPER

FORMED OF A SIN LAYER BY LOW TEMPERATURE ALD

AND METHOD OF FABRICATING THE SAME

CERTIFICATE OF MAILING UNDER 37 C.F.R. § 1.8

I hereby certify that this correspondence is being deposited with the United States Post Office as First Class Mail on the date indicated below in an envelope addressed to Mail Stop Issue Fee, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

10/5/5/

Date

Chelsey Davis

Mail Stop Issue Fee Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

AFFIRMATION OF AMENDMENT A FILED ON JULY 2, 2004

The applicants have noted that the Amendment A filed in the captioned application on July 2, 2004 was inadvertently filed without the signature of the undersigned attorney. The undersigned spoke to Examiner Pham today, October 5, 2004, about the unsigned Amendment. Examiner Pham explained that since the Amendment Transmittal document filed with the Amendment was signed, the entire paper is considered signed.

Notwithstanding the above, the undersigned hereby affirms the Amendment filed on July 2, 2004 in its entirety. A copy of the Amendment as filed on July 2, 2004 is enclosed. The undersigned has signed and dated the Amendment on even date herewith to affirm the contents of the Amendment as if it has been signed upon its filing in the United States Patent and Trademark Office on July 2, 2004.